

Title (en)
PACKAGING FOR MATERIALS SENSITIVE TO HUMIDITY

Publication
EP 0208259 A3 19880824 (DE)

Application
EP 86109050 A 19860703

Priority
DE 3524846 A 19850712

Abstract (en)
[origin: ES297122U] A package for photoresist material, particularly a dry resist, is substantially impermeable to water vapor, thereby preventing humidity-related effects which adversely influence the processability of the photoresist. The package can comprise a film tubing, the ends of which are closed by welding or gluing, into which a photoresist roll is placed. As the material for the film tubing, a composite material can be used which is formed of a polyester film as the support film, to which an aluminum foil is laminated or which is vacuum-metallized with aluminum and a polyethylene film laminated on top. A tinplate container can also be used as a package, the container being closed by soldering after placing the photoresist material inside the container. These packages generally have a permeability to water vapor of less than 0.01 gram of water vapor per square meter per day, at a humidity gradient of 97% and an ambient temperature of 23 DEG C.

IPC 1-7
B65D 65/40; **B65D 81/26**

IPC 8 full level
B65D 65/02 (2006.01); **B32B 15/085** (2006.01); **B65D 65/40** (2006.01); **B65D 81/26** (2006.01); **B65D 85/00** (2006.01)

CPC (source: EP KR US)
B65D 65/40 (2013.01 - KR); **B65D 81/26** (2013.01 - EP US); **B65D 81/268** (2013.01 - EP US); **Y10T 428/1338** (2015.01 - EP US); **Y10T 428/1359** (2015.01 - EP US)

Citation (search report)

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Designated contracting state (EPC)
AT DE FR GB IT NL

DOCDB simple family (publication)
EP 0208259 A2 19870114; **EP 0208259 A3 19880824**; **EP 0208259 B1 19900912**; AT E56414 T1 19900915; AU 590293 B2 19891102; AU 5973486 A 19870115; BR 8603257 A 19870224; DE 3524846 A1 19870115; DE 3674092 D1 19901018; ES 297122 U 19881116; ES 297122 Y 19890616; HK 14993 A 19930305; IL 79108 A0 19860930; JP S6216377 A 19870124; KR 870001493 A 19870314; SG 77292 G 19921224; US 4852732 A 19890801; ZA 865073 B 19870225

DOCDB simple family (application)
EP 86109050 A 19860703; AT 86109050 T 19860703; AU 5973486 A 19860703; BR 8603257 A 19860711; DE 3524846 A 19850712; DE 3674092 T 19860703; ES 297122 U 19880525; HK 14993 A 19930225; IL 7910886 A 19860612; JP 15990786 A 19860709; KR 860005606 A 19860711; SG 77292 A 19920729; US 88179486 A 19860703; ZA 865073 A 19860708